





#### **N-CHANNEL ENHANCEMENT MODE MOSFET**

#### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub>	I <sub>D</sub> T <sub>A</sub> = +25°C
20V	$0.55\Omega$ @ $V_{GS} = 4.5V$	630mA
20 V	$0.9\Omega @ V_{GS} = 1.8V$	410mA

### **Description**

This new generation MOSFET has been designed to minimize the onstate resistance (RDS(ON)) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

### **Applications**

- DC-DC Converters
- **Power Management Functions**

#### **Features and Benefits**

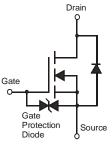
- Low On-Resistance:  $R_{DS(ON)} = 550_{(max)} m\Omega$  @  $V_{GS} = 4.5V$
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected up to 2KV
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 standards for High Reliability

#### **Mechanical Data**

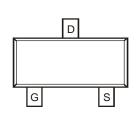
- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208 @3
- Terminal Connections: See Diagram
- Weight: 0.008 grams (approximate)











Top View

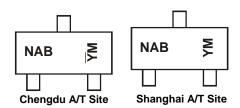
### Ordering Information (Note 4)

Part Number	Case	Packaging
DMN2004K-7	SOT23	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**



NAB = Product Type Marking Code YM = Date Code Marking for SAT (Shanghai Assembly/ Test site)

YM = Date Code Marking for CAT (Chengdu Assembly/ Test site) Y or  $\overline{Y}$  = Year (ex: A = 2013)

M = Month (ex: 9 = September)

Date Code Key

Year	2008		2009	2010		2011	2012		2013	2014		2015
Code	V		W	Х		Υ	Z		Α	В		С
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

1 of 6 July 2013 **DMN2004K** © Diodes Incorporated Document number: DS30938 Rev. 9 - 2

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#### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characte	eristic		Symbol	Value	Units
Drain-Source Voltage			V <sub>DSS</sub>	20	V
Gate-Source Voltage			V <sub>GSS</sub>	±8	V
Drain Current (Note 5) V <sub>GS</sub> = 4.5V	Steady State	$T_A = +25^{\circ}C$ $T_A = +85^{\circ}C$	I <sub>D</sub>	630 450	mA
Drain Current (Note 5) V <sub>GS</sub> = 1.8V	Steady State	$T_A = +25^{\circ}C$ $T_A = +85^{\circ}C$	I <sub>D</sub>	410 300	mA
Pulsed Drain Current (Note 6)			I <sub>DM</sub>	1.5	Α

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 5)	P <sub>D</sub>	350	mW
Thermal Resistance, Junction to Ambient	$R_{ heta JA}$	357	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

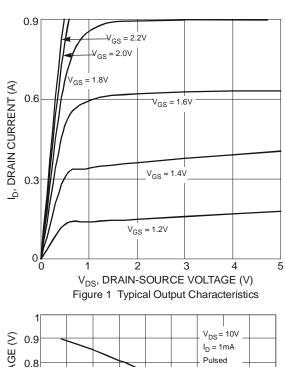
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	20	_	_	V	$V_{GS} = 0V, I_{D} = 10\mu A$
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μA	V <sub>DS</sub> = 16V, V <sub>GS</sub> = 0V
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±1	μA	$V_{GS} = \pm 4.5V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	$V_{GS(th)}$	0.5	_	1.0	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$
			0.4	0.55		$V_{GS} = 4.5V, I_D = 540mA$
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	0.5	0.70	Ω	$V_{GS} = 2.5V, I_D = 500mA$
			0.7	0.9		$V_{GS} = 1.8V, I_D = 350mA$
Forward Transfer Admittance	Y <sub>fs</sub>	200	_	_	ms	$V_{DS} = 10V, I_D = 0.2A$
Source Current	Is	_	_	0.5	Α	_
Diode Forward Voltage (Note 7)	V <sub>SD</sub>	0.6	_	1	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 500mA
DYNAMIC CHARACTERISTICS						
Input Capacitance	Ciss		_	150	pF	.,, .,
Output Capacitance	Coss		_	25	pF	$V_{DS} = 16V, V_{GS} = 0V$ f = 1.0MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	_	_	20	pF	
Gate Resistance	$R_g$	_	292	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge	$Q_g$		0.9	_		
Gate-Source Charge	$Q_{gs}$	_	0.2	_	nC	$V_{DS} = 15V, V_{GS} = 4.5V, I_{D} = 0.5A$
Gate-Drain Charge	$Q_{gd}$	_	0.2	_		
Turn-On Delay Time	t <sub>D(on)</sub>	_	5.7	_		
Turn-On Rise Time	t <sub>r</sub>	_	8.4	_		$V_{GS} = 8V, V_{DS} = 15V,$
Turn-Off Delay Time	t <sub>D(off)</sub>	_	59.4	_	ns	$R_G = 6\Omega$ , $R_L = 30\Omega$
Turn-Off Fall Time	t <sub>f</sub>		37.6	—		
Body Diode Reverse Recovery Time	t <sub>rr</sub>		5.5	—	ns	I <sub>S</sub> = 0.5A, dI/dt = -100A/μs
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>		0.85		nC	$I_S = 0.5A$ , $dI/dt = -100A/\mu s$

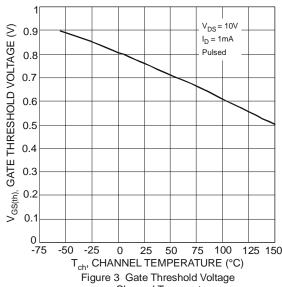
Notes:

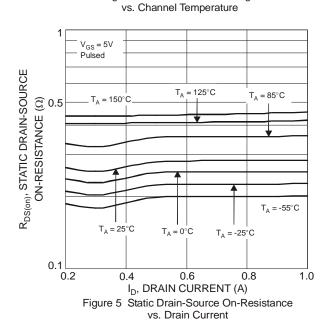
- 5. Device mounted on FR-4 PCB, with minimum recommended pad layout, single sided.
- 6. Pulse width ≤10µS, Duty Cycle ≤1%.
  7. Short duration pulse test used to minimize self-heating effect.

2 of 6 DMN2004K Document number: DS30938 Rev. 9 - 2 Downloaded From Oneyac.com









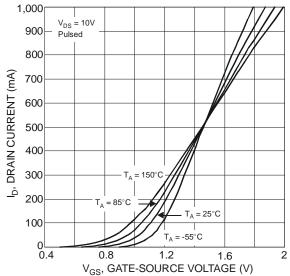


Figure 2 Reverse Drain Current vs. Source-Drain Voltage

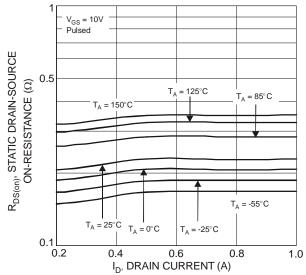


Figure 4 Static Drain-Source On-Resistance vs. Drain Current

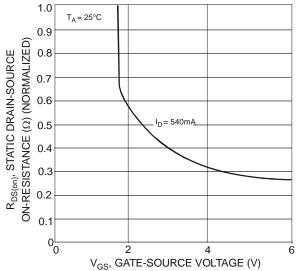


Figure 6 Static Drain-Source, On-Resistance vs. Gate-Source Voltage



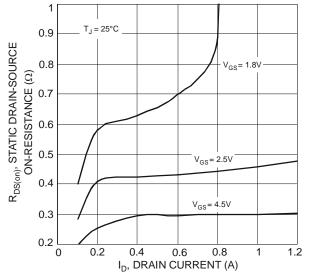
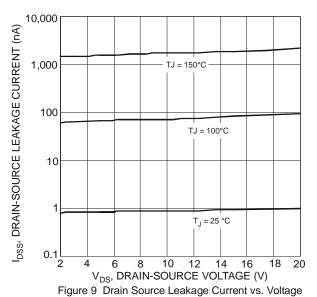


Figure 7 On-Resistance vs. Drain Current and Gate Voltage



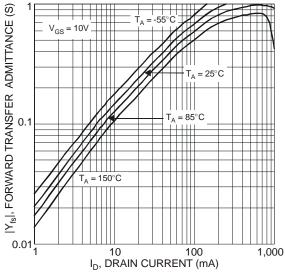


Figure 11 Forward Transfer Admittance vs. Drain Current

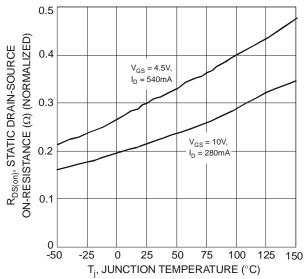


Figure 8 Static Drain-Source, On-Resistance vs. Temperature

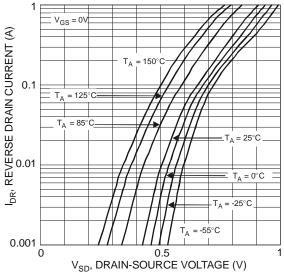
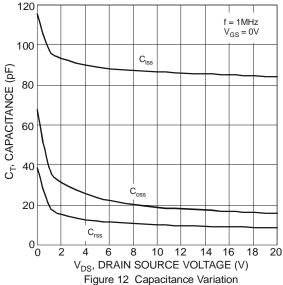
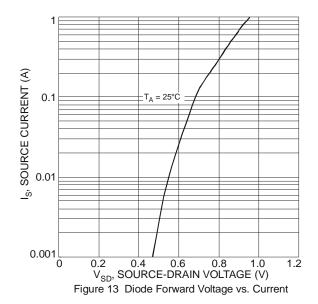
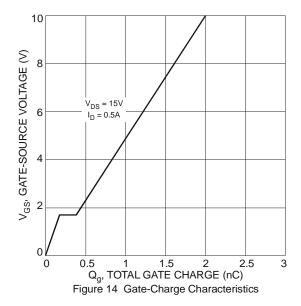


Figure 10 Reverse Drain Current vs. Source-Drain Voltage



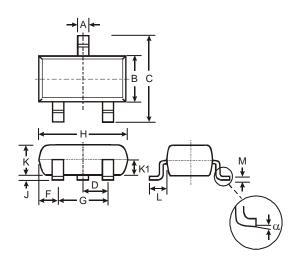






### **Package Outline Dimensions**

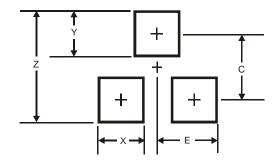
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT23								
Dim	Min	Max	Тур					
Α	0.37	0.51	0.40					
В	1.20	1.40	1.30					
С	2.30	2.50	2.40					
D	0.89	1.03	0.915					
F	0.45	0.60	0.535					
G	1.78	2.05	1.83					
H	2.80	3.00	2.90					
7	0.013	0.10	0.05					
K	0.903	1.10	1.00					
K1	-	1	0.400					
L	0.45	0.61	0.55					
М	0.085	0.18	0.11					
α	0°	8°	-					
All Dimensions in mm								

## **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.



Dimensions	Value (in mm)			
Z	2.9			
Х	0.8			
Υ	0.9			
С	2.0			
E	1.35			



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